

# MINIATURE RELAY

# 1 POLE—1 to 2 A (FOR SIGNAL SWITCHING)

# FBR211 SERIES

RoHS compliant



#### **■ FEATURES**

- 2 A maximum carrying current
   Capable of 2 A maximum continuous carrying current in the contact
- Superior reliability gold-overlay contacts
   P type: Gold-overlay silver-palladium contacts
- International terminal pitch of one inch grid terminal layout
- High sensitivity, low power dissipation types also available Standard types: 0.45 W (A or B type)
   High sensitivity types: 0.2 W (C or E type)
- Conforms to FCC 68.302 (high dielectric strength type)
- UL recognized (File number E63615)
- CSA recognized (File number LR64026)
- RoHS compliant since date code: 0433A
   Please see page 5 for more information



#### ■ ORDERING INFORMATION

(a)	Series Name	FBR211			
(b)	Enclosure	S: Flux free type N: Plastic sealed type			
(c)	Coil Power and Schematics	A: Standard A type (nominal power 450 mW type) B: Standard B type C: High sensitivity C type (nominal power 200 mW type) E: High sensitivity E type			
(d)	Nominal Voltage	(Example) D003: 3 VDC D012: 12 VDC (refer to the COIL DATA CHART)			
(e)	UL Marking on Cover	Nil : No UL marking U : UL marking			
(f)	Contact Material	P : Gold-overlay silver-palladium M : Gold-overlay silver			
(g)	Special Type	Nil : Standard 2 : High dielectric strength type			
(h)	CSA Marking	Nil : Standard -CSA : UL + CSA marking (valid when (e) is U)			

Note: The designation name is stamped on the top of the relay case as follows: (Example) Designation ordered: FBR211SAD005-P
Stamp: 211SAD005-P

1

### **■ COIL DATA CHART**

### 1. STANDARD (A or B type)

MODEL				Nominal	Coil	Nominal current	Must	Must	Maximum	Nominal	Coil
A type B type		voltage	resistance (±10%)	(at nominal voltage)		release voltage	allowable voltage	power	temperature		
Flux free	Plastic sealed	Flux free	Plastic sealed		(±1070)	approx.	voitage	voitage	voitage	<b>,</b>	1136
FBR211SAD001-n	FBR211NAD001-n	FBR211SBD001-n	FBR211NBD001-n	1.5 VDC	5 Ω	300 mA					
FBR211SAD003-n	FBR211NAD003-n	FBR211SBD003-n	FBR211NBD003-n	3 VDC	20 Ω	150 mA		10% min.	6 min. 150% of pminal nominal tage (a	Approx. 450 mW (at nominal ( voltage)	Approx. 45 deg (at nominal voltage)
FBR211SAD005-n	FBR211NAD005-n	FBR211SBD005-n	FBR211NBD005-n	5 VDC	56 Ω	89 mA	70% max.				
FBR211SAD006-n	FBR211NAD006-n	FBR211SBD006-n	FBR211NBD006-n	6 VDC	80 Ω	75 mA	of nominal voltage	of nominal voltage			
FBR211SAD009-n	FBR211NAD009-n	FBR211SBD009-n	FBR211NBD009-n	9 VDC	180 Ω	50 mA	voitage voitage	vollage			
FBR211SAD012-n	FBR211NAD012-n	FBR211SBD012-n	FBR211NBD012-n	12 VDC	320 Ω	38 mA					
FBR211SAD024-n	FBR211NAD024-n	FBR211SBD024-n	FBR211NBD024-n	24 VDC	1,280 Ω	19 mA					

Note: All values in the table are measured at 20°C.

#### 2. HIGH SENSITIVITY (C or E type)

MODEL				Nominal	Coil	Nominal current	Must	Must	Maximum	Nominal	Coil
C type		E type		voltage	resistance (±10%)	1		release voltage	allowable voltage	power	temperature
Flux free	Plastic sealed	Flux free	Plastic sealed	3	(±1070)	approx.	voitage	voitage	voitage		1136
FBR211SCD001-n	FBR211NCD001-n	FBR211SED001-n	FBR211NED001-n	1.5 VDC	12 Ω	125 mA					
FBR211SCD003-n	FBR211NCD003-n	FBR211SED003-n	FBR211NED003-n	3 VDC	45 Ω	67 mA	70% max. 1	10% min.		Approx. 200 mW (at nominal	Approx. 25 deg (at nominal
FBR211SCD005-n	FBR211NCD005-n	FBR211SED005-n	FBR211NED005-n	5 VDC	120 Ω	42 mA					
FBR211SCD006-n	FBR211NCD006-n	FBR211SED006-n	FBR211NED006-n	6 VDC	180 Ω	33 mA	of nominal	of nominal voltage			
FBR211SCD009-n	FBR211NCD009-n	FBR211SED009-n	FBR211NED009-n	9 VDC	400 Ω	23 mA	voltage voltage	voltage (at none	voltage)	voltage)	
FBR211SCD012-n	FBR211NCD012-n	FBR211SED012-n	FBR211NED012-n	12 VDC	700 Ω	17 mA					
FBR211SCD024-n	FBR211NCD024-n	FBR211SED024-n	FBR211NED024-n	24 VDC	2,800 Ω	9 mA					

Note: All values in the table are measured at 20°C.

#### ■ SPECIFICATIONS

ltem			Standard (A or B type)	High sensitive (C or E type)			
Contact	Arrangement		1 form C (SPDT)				
	Material		Gold-overlay silver-palladium / gold-overlay silver				
	Resistance (	initial)	Maximum 100 mΩ (at 0.1 A 6 VDC)				
	Rating (resis	tive)	0.5 A 120 VAC or 1 A 28 VDC				
	Maximum Ca	arrying Current	2 A				
	Maximum Sv	witching Power	60 VA or 28 W				
	Max. Switch	ing Voltage*1	220 VAC or 150 VDC				
	Maximum Sv	witching Current	1.25 A (AC) or 2 A (DC)				
	Minimum Switching load*2 (reference)		Plastic sealed 1 mA, 1V Flux free 1 mA, 5V				
Coil	Nominal Power (at 20°C)		Approximately 450 mW	Approximately 200 mW			
	Operate Pov	ver (at 20°C)	Approximately 315 mW maximum	Approximately 140 mW maximum			
	Operating Te	emperature	–25°C to +55°C (no frost)	-25°C to +75°C (no frost)			
	Operating H	umidity	45 to 85%RH				
Time Value	Operate (at nominal voltage)		Maximum 5 ms				
	Release (at nominal voltage)		Maximum 5 ms				
Life	Mechanical		5 × 10 <sup>6</sup> operations minimum				
	Electrical (Refer to the REFERENCE DATA)		$3 \times 10^5$ operations minimum (at $1 \text{ A}/28 \text{ VDC}$ resistive load) $1 \times 10^5$ operations minimum (at $2 \text{ A}/12 \text{ VDC}$ resistive load) $1 \times 10^5$ operations minimum (at $0.5 \text{ A}/120 \text{ VDC}$ resistive load)				
Other	Vibration Resistance		10 to 55 Hz (double amplitude of 1.5 mm)				
	Shock Resistance	Misoperation	100 m/s <sup>2</sup> (11± <sup>1</sup> ms)	60 m/s <sup>2</sup> (11± <sup>1</sup> ms)			
		Endurance	1,000 m/s <sup>2</sup> (11± <sup>1</sup> ms)				
	Weight		Approximately 4 g				

<sup>\*1</sup> If the switching voltage exceeds the rated contact voltage, reduce the current. The current values vary according to the type of load.

#### **■ INSULATION**

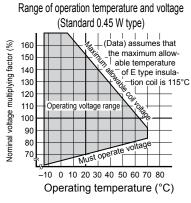
Item		Standard (A or B)	High sensitive (C or E)		
Isolation (initia	l)	Minimum 100 MΩ (at 500VDC)			
Dielectric		500VAC 1 min. (standard)			
Strength		1,500VAC 1 min. (high isolation	coil and contact)		

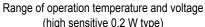
#### ■ SAFETY STANDARDS

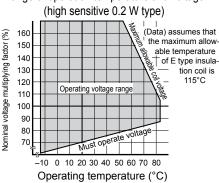
Туре	Compliance	Contact rating
UL	UL 110	Flammability: UL 94-V0 (plastics)
	E63615	0.5A, 120VAC (resistive)
CSA	C22.2 No. 14	1A, 28VDC (resistive)
	LR 40304, LR 46016	

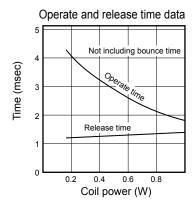
<sup>\*2</sup> Values when switching a resistive load at normal room temperature and humidity and in a clean environment. The minimum switching load varies with the switching frequency and operation environment.

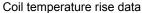
#### CHARACTERISTIC DATA

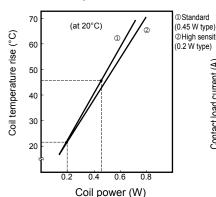




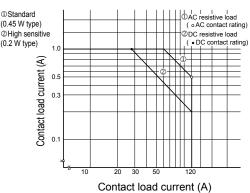


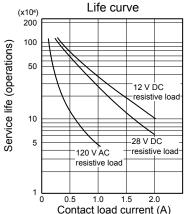






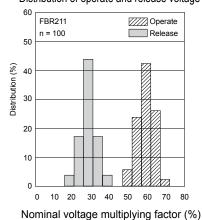
Maximum switching capacity



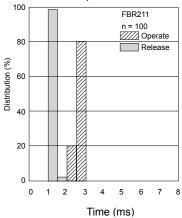


#### REFERENCE DATA

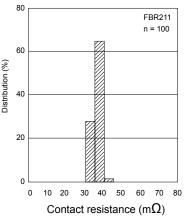
Distribution of operate and release voltage



Distribution of operate and release time

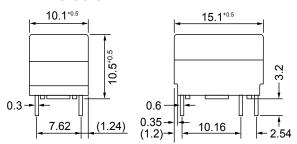


Distribution of contact resistance

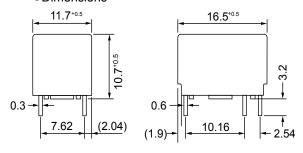


#### **■** DIMENSIONS

- 1. STANDARD (Flux free type)
  - Dimensions



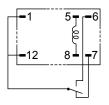
- 2. N-TYPE (Plastic sealed type)
  - Dimensions

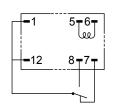


●Schematics (BOTTOM VIEW)

(A type or C type)

(B type or E type)

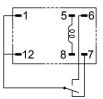


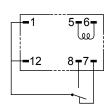


●Schematics (BOTTOM VIEW)

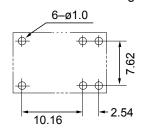
(A type or C type)

(B type or E type)





- 3. PC BOARD MOUNTING HOLE LAYOUT
  - ●PC board mounting hole layout (BOTTOM VIEW)



Unit: mm

### **RoHS Compliance and Lead Free Relay Information**

#### 1. General Information

- Relays produced after the specific date code that is indicated on each data sheet are lead-free
  now. Most of our signal and power relays are lead-free. Please refer to Lead-Free Status Info.
  (http://www.fujitsu.com/us/downloads/MICRO/fcai/relays/lead-free-letter.pdf)
- Lead free solder paste currently used in relays is Sn-3.0Aq-0.5Cu.
- All signal and most power relays also comply with RoHS. Please refer to individual data sheets. Relays that are RoHS compliant do not contain the 5 hazardous materials that are restricted by RoHS directive (lead, mercury, chromium IV, PBB, PBDE).
- It has been verified that using lead-free relays in leaded assembly process will not cause any problems (compatible).
- "LF" is marked on each outer and inner carton. (No marking on individual relays).
- To avoid leaded relays (for lead-free sample, etc.) please consult with area sales office.
- We will ship leaded relays as long as the leaded relay inventory exists.

Note: Cadmium was exempted from RoHS on October 21, 2005. (Amendment to Directive 2002/95/EC)

#### 2. Recommended Lead Free Solder Profile

• Recommended solder paste Sn-3.0Ag-0.5Cu.

#### **Reflow Solder condition**

#### Flow Solder condition:

Pre-heating: maximum 120°C dip within 5 sec. at 260°C soler bath

#### Solder by Soldering Iron:

Soldering Iron

Temperature: maximum 360°C Duration: maximum 3 sec.

We highly recommend that you confirm your actual solder conditions

### 3. Moisture Sensitivity

Moisture Sensitivity Level standard is not applicable to electromechanical realys.

#### 4. Tin Whisker

 Dipped SnAgCu solder is known as low risk tin whisker. No considerable length whisker was found by our in house test.

#### **Fujitsu Components International Headquarter Offices**

Japan

Fujitsu Component Limited Gotanda-Chuo Building

3-5, Higashigotanda 2-chome, Shinagawa-ku

Tokyo 141, Japan Tel: (81-3) 5449-7010 Fax: (81-3) 5449-2626

Email: promothq@ft.ed.fujitsu.com

Web: www.fcl.fujitsu.com

North and South America

Fujitsu Components America, Inc. 250 E. Caribbean Drive Sunnyvale, CA 94089 U.S.A. Tel: (1-408) 745-4900 Fax: (1-408) 745-4970

Email: components@us.fujitsu.com

Web: http://www.fujitsu.com/us/services/edevices/components/

Europe

Fujitsu Components Europe B.V.

Diamantlaan 25 2132 WV Hoofddorp Netherlands Tel: (31-23) 5560910 Fax: (31-23) 5560950 Email: info@fceu.fujitsu.com

Web: emea.fujitsu.com/components/

Asia Pacific

Fujitsu Components Asia Ltd. 102E Pasir Panjang Road #01-01 Citilink Warehouse Complex

Singapore 118529 Tel: (65) 6375-8560

Fax: (65) 6273-3021 Email: fcal@fcal.fujitsu.com

Web: http://www.fujitsu.com/sg/services/micro/components/

©2008 Fujitsu Components America, Inc. All rights reserved. All trademarks or registered trademarks are the property of their respective owners.

Fujitsu Components America or its affiliates do not warrant that the content of datasheet is error free. In a continuing effort to improve our products Fujitsu Components America, Inc. or its affiliates reserve the right to change specifications/datasheets without prior notice. Rev. January 18, 2008.